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[Upgrade to revision]

R20TS0677EJ0100

Rev.1.00

Apr. 01, 2021

Solution Toolkit

QE for BLE[RA, RE] V1.2.0:

Development Assistance Tool for Bluetooth® low energy

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## Overview

The product in the title has been revised and its version number has been changed as follows.

- QE for BLE[RA], the development assistance tool for Bluetooth® low energy: From V1.1.0 to V1.2.0

The product name has been changed to reflect the addition of supported microcontrollers.

## 1. Version to Be Updated

- QE for BLE[RA] V1.1.0

How to check the version: In e<sup>2</sup> studio, select [Help] and then [e<sup>2</sup> studio Installation Details], open the [Installed Software] tab, and then check the version of Renesas QE for BLE[RA].

## 2. Items Revised

The major revision points are as follows. For details and how to install the product, refer to the following release note.

- QE for BLE[RA, RE] V1.2.0 Release Note

<https://www.renesas.com/search/keyword-search.html-genre=document&q=r20ut4951>

### 2.1 Addition of Supported Devices

Support has been added for the following device group.

RE family: RE01B group

For the list of supported devices, refer to the following URL:

<https://www.renesas.com/qe-ble>

## 3. Operating Environment

- Integrated development environment e<sup>2</sup> studio 2021- 01 or later

For details about how to use this product, refer to the QE items from the [Help] menu of e<sup>2</sup> studio.

### 4. Supporting Sample Programs

You can obtain sample programs that support this product from the URL below:

<https://www.renesas.com/search/keyword-search.html#genre=sampleprogram&q=r01an5606>

RE01B Group Bluetooth Low Energy Sample Code (using CMSIS Driver Package) (R01AN5606)

### 5. Obtaining the Product

Download the installer for QE for BLE[RA, RE] V1.2.0 from the following URL:

<https://www.renesas.com/qe-ble>

**Revision History**

Rev.	Date	Description	
		Page	Summary
1.00	Apr.01.21	-	First edition issued

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